AMENDMENTS TO THE CLAIMS:

The listing of claims will replace all prior versions, and listing, of claims in the application:

LISTING OF CLAIMS

Claims 1-8 (canceled).

- 9. (previously presented) A photoresist laminate comprising:
- 2 a substrate;
- a photoresist pattern with a reinforcing section formed by using an exposure and a developing solution,
- a sublayer film provided between the substrate and the photoresist pattern, the sublayer
- 6 film being soluble in a developing solution used to form the photoresist pattern; and
- 7 wherein there is provided in said photoresist pattern line section and a reinforcing section
- 8 that continues to said line section and that has a greater width than a line width of said line
- 9 section.

Claims 10-13 (canceled).